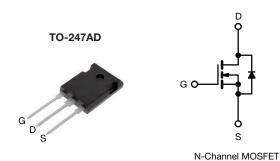
Vishay Siliconix

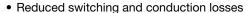
E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	85	50			
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V	0.205			
Q _g max. (nC)	7	2			
Q _{gs} (nC)	(9			
Q _{gd} (nC)	22				
Configuration	Sin	Single			

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Co(er))



Avalanche energy rated (UIS)

 Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-247AD
Lead (Pb)-free and halogen-free	SiHW21N80AE-GE3

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	800	V
Gate-source voltage			V_{GS}	± 30	7 V
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	- I _D	17.4	А
	V _{GS} at 10 V	T _C = 100 °C		11	
Pulsed drain current ^a			I _{DM}	38	
Linear derating factor				1.4	W/°C
Single pulse avalanche energy b			E _{AS}	127	mJ
Maximum power dissipation			P_{D}	179	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope $T_J = 125 ^{\circ}\text{C}$		dv/dt	70	\//no	
Reverse diode dv/dt ^d			39	- V/ns	
Soldering recommendations (peak temperature) c For 10 s				260	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 1.5 A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, di/dt = 100 A/ μ s, starting $T_J = 25$ °C



Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	=	40	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	0.7	C/VV

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•			•	•	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.8	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Onto anima lankana		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
7		V _{DS} =	$V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}$		-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 640 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 11 A	-	0.205	0.235	Ω
Forward transconductance a	9 _{fs}	V _{DS}	V _{DS} = 30 V, I _D = 3 A		4.0	-	S
Dynamic					•	•	
Input capacitance	C _{iss}	V _{GS} = 0 V,		-	1388	-	pF
Output capacitance	C _{oss}	,	$V_{DS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		53	-	
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	5	-	
Effective output capacitance, energy related ^a	$C_{o(er)}$			-	43	-	
Effective output capacitance, time related ^b	C _{o(tr)}	V _{DS} = 0 \	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		276	-	
Total gate charge	Qg			-	48	72	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_D = 11 \text{ A}, V_{DS} = 640 \text{ V}$	-	9	-	nC
Gate-drain charge	Q _{gd}			-	22	-	
Turn-on delay time	t _{d(on)}			-	21	42	
Rise time	t _r	V _{DD} = 640 V, I _D = 11 A,		-	38	76	
Turn-off delay time	t _{d(off)}	V _{GS} =	$V_{GS} = 10 \text{ V}, R_g = 20 \Omega$		71	107	ns
Fall time	t _f			-	76	114	
Gate input resistance	R_g	f = 1 MHz, open drain		0.2	0.55	1.1	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	showing the	MOSFET symbol showing the		-	17.4	_
Pulsed diode forward current	I _{SM}	integral revers p - n junction		-	-	38	A
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 11 A, V _{GS} = 0 V	-	-	1.2	٧
Reverse recovery time	t _{rr}			-	400	800	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C, } I_F = I_S = 11 \text{ A,}$ di/dt = 100 A/ μ s, $V_R = 25 \text{ V}$		-	5	10	μC
Reverse recovery current	I _{RRM}			-	20	-	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

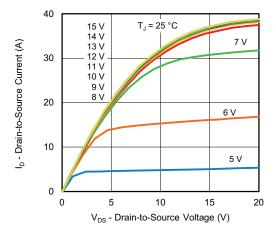


Fig. 1 - Typical Output Characteristics

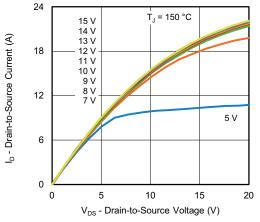


Fig. 2 - Typical Output Characteristics

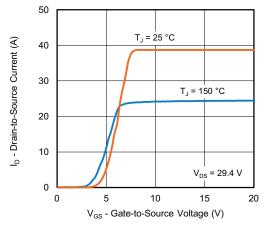


Fig. 3 - Typical Transfer Characteristics

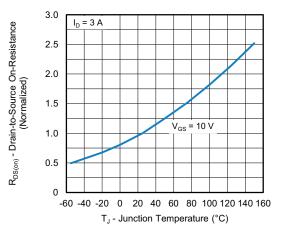


Fig. 4 - Normalized On-Resistance vs. Temperature

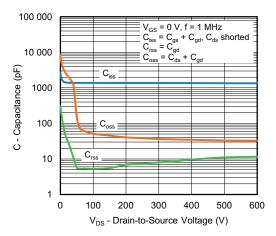


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

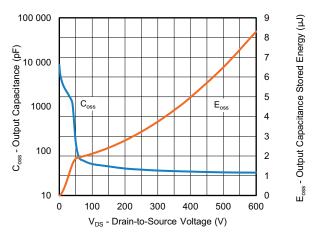


Fig. 6 - Coss and Eoss vs. VDS



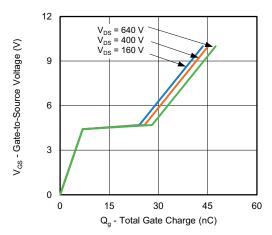


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

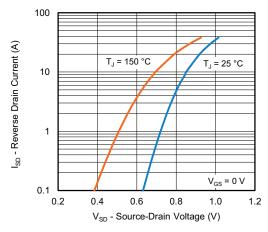


Fig. 8 - Typical Source-Drain Diode Forward Voltage

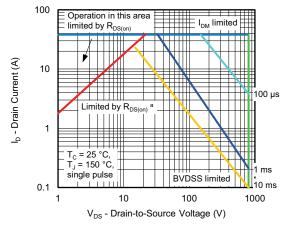


Fig. 9 - Maximum Safe Operating Area



a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

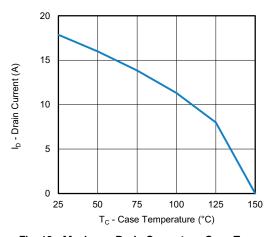


Fig. 10 - Maximum Drain Current vs. Case Temperature

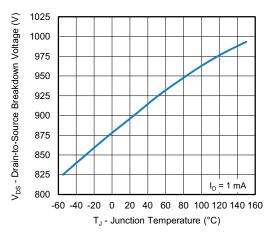


Fig. 11 - Temperature vs. Drain-to-Source Voltage



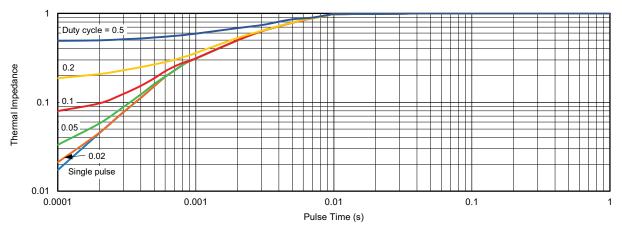


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

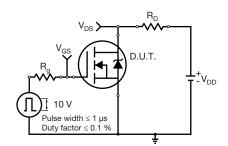


Fig. 13 - Switching Time Test Circuit

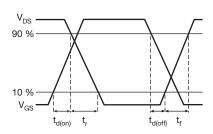


Fig. 14 - Switching Time Waveforms

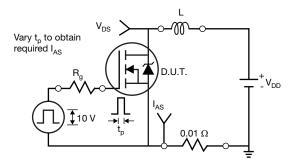


Fig. 15 - Unclamped Inductive Test Circuit



Fig. 16 - Unclamped Inductive Waveforms

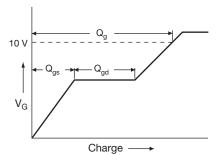


Fig. 17 - Basic Gate Charge Waveform

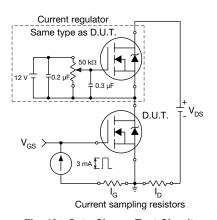
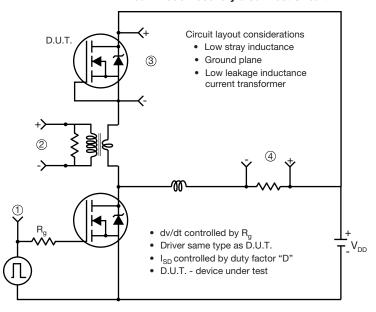


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dv/dt Test Circuit



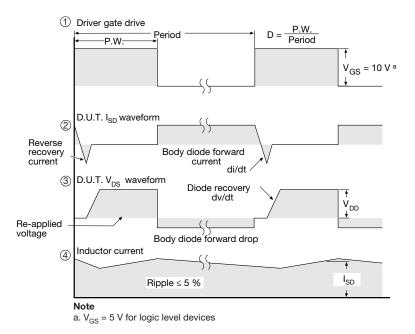
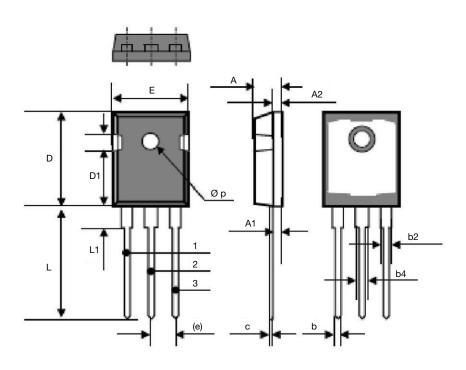


Fig. 19 - For N-Channel

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TO-247AD (High Voltage)



DIM.	MILLIM	IETERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.70	5.31	0.185	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b2	1.65	2.41	0.065	0.095	
b4	2.59	3.43	0.102	0.135	
С	0.61 BSC		0.024 BSC		
D	20.80	21.46	0.819	0.845	
D1	3.68	5.49	0.145	0.216	
(e)	5.46 BSC		0.215	BSC	
Е	15.49	16.26	0.610	0.640	
L	19.81	20.32	0.780	0.800	
L1	4.06	4.50	0.160	0.177	
Øр	3.51	3.66	0.138	0.144	

ECN: S17-0178-Rev. B, 06-Feb-17

DWG: 6010



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Vishay

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